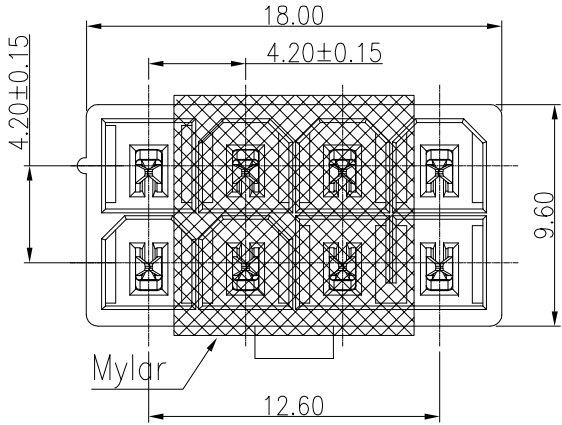
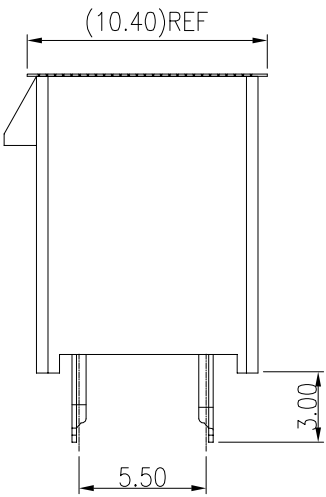
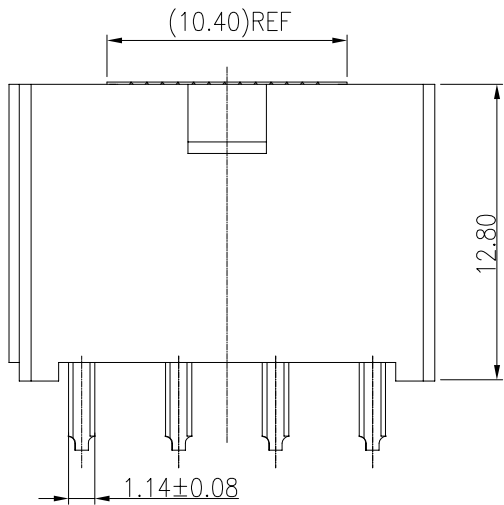


RECOMMENDED PCB LAYOUT



NOTE:
1.MATERIAL SPECIFICATION:
1-1.HOUSING: PA66/LCP
1-2.CONTACTS: BRASS
2.PLATING SPECIFICATION:
2-1.CONTACTS:
TIN/GOLD FLASH PLATED OVER ALL.
3.ELECTRICAL PERFORMANCE:
3-1.CURRENT RATING: 9A AC/DC
3-2.CONTACT RESISTANCE: 20 mΩ MAX
3-3.INSULATION RESISTANCE: 1000MΩ Min
3-4.DIELECTRIC WITHSTANDING : 1500V
4.ENVIRONMENTAL PERFORMANCE:
4-1.OPERATING TEMPERATURE: -25°C~+85°C/PA66
OPERATING TEMPERATURE: -40°C~+105°C/LCP
5.PACKAGE SPEC: REEL
6.P/N:
A1 C4201 W 0 4-2 XX 1 X X X
SERIES NO: HOUSING:
0-PA66,UL94V-0
2-PA66,UL94V-2
3-LCP,UL94V-0(RoHS+HF)
CONNECTOR: W-WAFER
COLOR:
A-BLACK
S-NATURE
ANGLE: 0-180°
TYPE: 4-TYPE 4
PLATING:
C-BRIGHT TIN
ROW NO: 2-DOUBLE ROW
PIN Q'PY: 08
TERMIPOINT:
1-DIP

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: C4201W04-2XX1XXX	DWG.NO: ENDE05	 WanLian Technology Co., Ltd	
A0	NEW RELEASE	21.11.17		LINEAR	ANGLES	APPROVED	Wang_jr	23.09.11	TITLE: Pitch 4.2mm 双排 180° DIP Wafer 空 心针 连PIN 特殊款	REV: A1		SHEET: 1/1
A1	PART NUMBER RENEWAL	23.09.11		0.0±0.35	X°REF±6°	DESIGNER	Han_Gao	23.09.11				
				UNIT:mm	0.00±0.25		X°±3°	DRAWN				
			SIZE: A4	0.000±0.10	X°X° ±2°							